



Low-Voltage, 0.8- Ω r_{ON} , Dual SPST Analog Switch

FEATURES

- Low Voltage Operation (1.6 V to 3.6 V)
- Low On-Resistance - $r_{DS(on)}$:
0.8 Ω @ 2.7 V
- High Current Handling Capacity:
150-mA Continuous
- Off-Isolation: -56 dB @ 1 MHz
- Fast Switching: 25 ns t_{ON}
- Low Charge Injection— Q_{INJ} : 5.8 pC
- Low Power Consumption: < 1 μ W
- ESD Protection > 2,000 V

BENEFITS

- High Accuracy
- High Bandwidth
- TTL and Low Voltage Logic Compatibility
- Low Power Consumption
- Reduced PCB Space (SOT23-8 and MSOP-8)

APPLICATIONS

- Mixed Signal Routing
- Portable and Battery Operated Systems
- Low Voltage Data Acquisition
- Modems
- PCMCIA Cards

DESCRIPTION

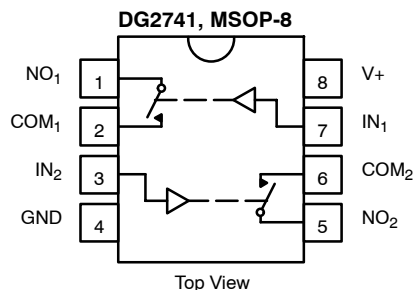
The DG2741/2742/2743 are low voltage, single supply, dual SPST analog switches. Designed for high performance switching of analog signals, the DG2741/2742/2743 provide low on-resistance (0.8 Ω @ +2.7 V), fast speed (t_{ON} , t_{OFF} @ 35 ns and 33 ns) and the ability to handle signals over the entire analog voltage range.

When operated on a +3-V supply, control pins are compatible with 1.8-V digital logic. Additionally, on-resistance flatness and matching (0.18 Ω and 0.08 Ω , respectively) offer high accuracy between channels.

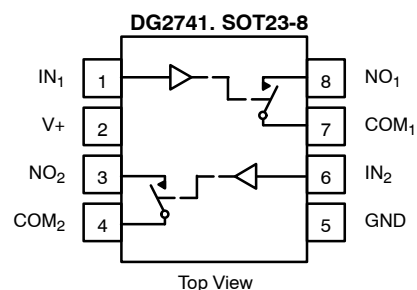
The DG2741 contains two normally open (NO) switches, the DG2742 contains two normally closed (NC) switches, and the DG2743 contains one normally open and one normally closed switch. Break-before-make is guaranteed.

Built on Vishay Siliconix's low voltage submicron CMOS process, the DG2741/2742/2743 were designed to offer solutions that extend beyond audio/video functions, to providing the performance required for today's demanding mixed-signal switching in portable applications.

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION—DG2741



Device Marking: 2741

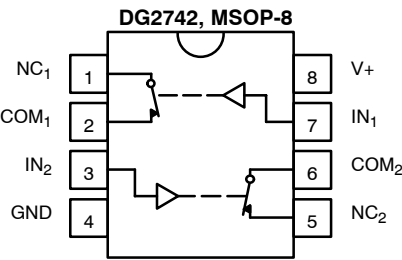


Device Marking: F3

TRUTH TABLE - DG2741	
Logic	Switch
0	Off
1	On

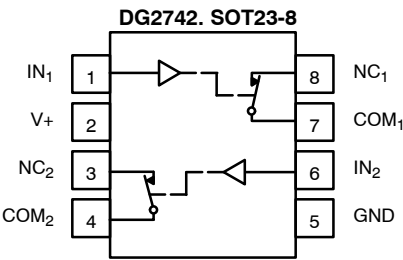


FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION—DG2742/DG2743



Top View

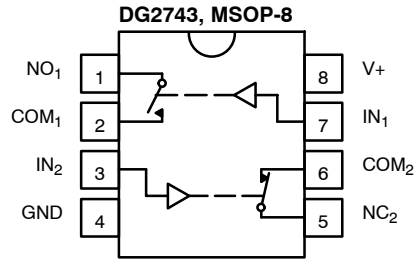
Device Marking: 2742



Top View

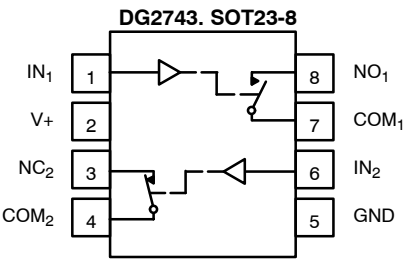
Device Marking: F4

TRUTH TABLE - DG2742	
Logic	Switch
0	On
1	Off



Top View

Device Marking: 2743



Top View

Device Marking: F5

TRUTH TABLE - DG2743		
Logic	Switch-1	Switch-2
0	Off	On
1	On	Off

ORDERING INFORMATION		
Temp Range	Package	Part Number
-40 to 85°C	MSOP-8	DG2741DQ-T1
		DG2742DQ-T1
		DG2743DQ-T1
	SOT23-8	DG2741DS-T1
		DG2742DS-T1
		DG2743DS-T1

**ABSOLUTE MAXIMUM RATINGS**

Reference to GND

V+ -0.3 to +4 V

IN, COM, NC, NO^a -0.3 to (V+ + 0.3 V)

Continuous Current (NO, NC and COM Pins) ±200 mA

Peak Current ±300 mA
(Pulsed at 1 ms, 10% duty cycle)

ESD per Method 3015.7 > 2 kV

Storage Temperature (D Suffix) -65 to 150°C

Power Dissipation (Packages)^c6-Pin SC-70^c 250 mW**Notes:**

- Signals on NC, NO, or COM or IN exceeding V+ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- All leads welded or soldered to PC Board.
- Derate 3.1 mW/°C above 70°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

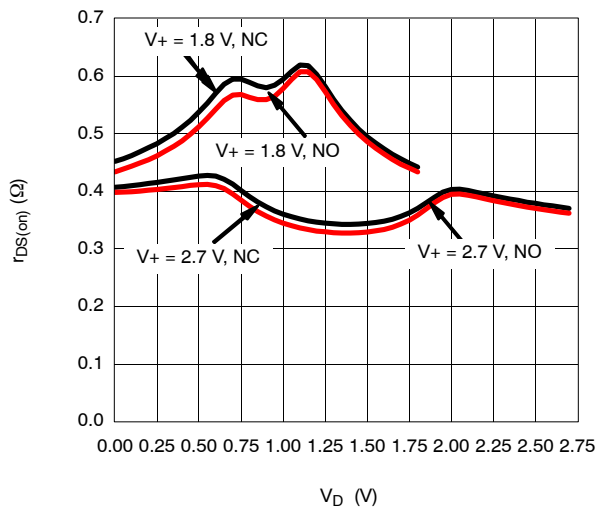
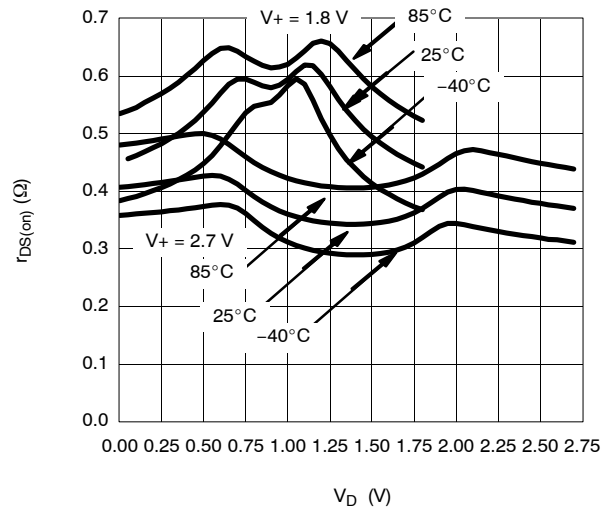
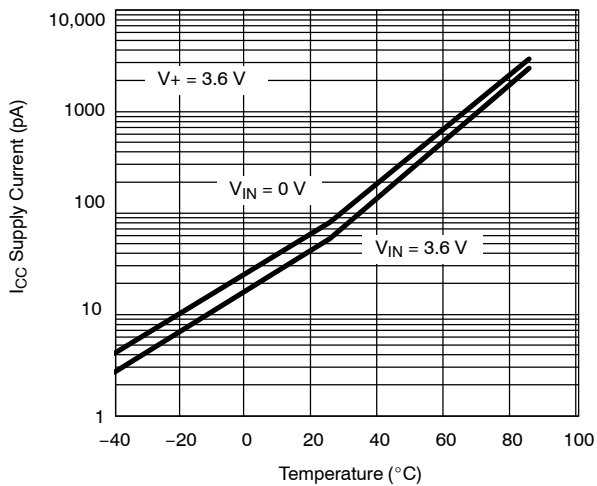
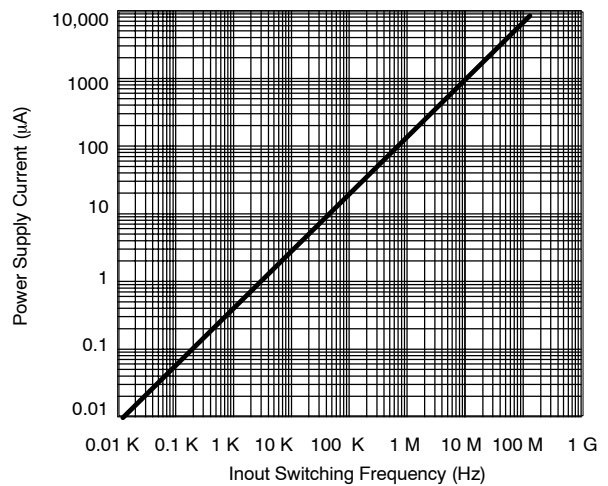
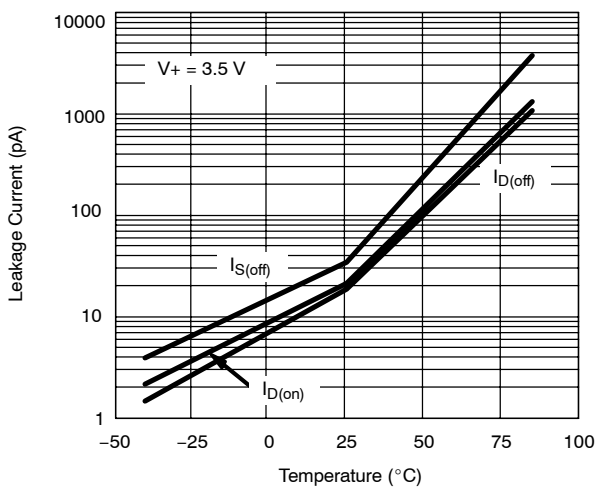
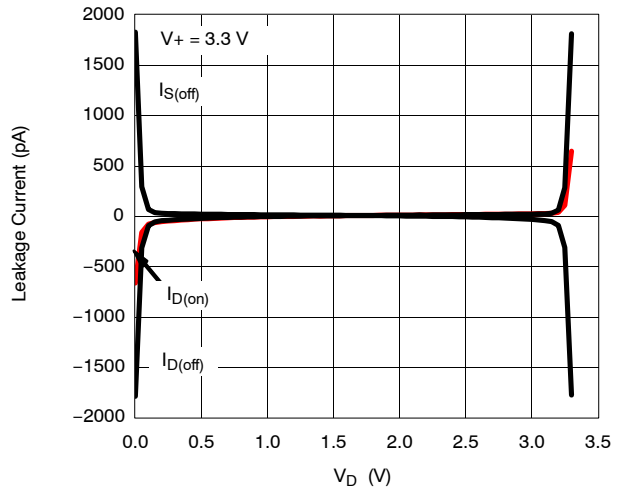
SPECIFICATIONS (V+ = 1.8 V)

Parameter	Symbol	Test Conditions Otherwise Unless Specified V+ = 1.8 V, ± 10%, VIN = 0.4 or 1.0 V ^e	Temp ^a	Limits −40 to 85°C			Unit
				Min ^b	Typ ^c	Max ^b	
Analog Switch							
Analog Signal Range ^d	VNO, VNC, VCOM		Full	0		V+	V
On-Resistance	rON	V+ = 1.8 V, VCOM = 0.9 V INO, INC = 10 mA	Room Full ^d		0.9	2.5 4.0	Ω
rON Flatness ^d	rON Flatness	V+ = 1.8 V, VCOM = 0 to V+, INO, INC = 10 mA	Room		0.25		
rON Match ^d	ΔrON		Room		0.05		
Switch Off Leakage Current ^f	INO(off), INC(off)	V+ = 1.8 V VNO, VNC = 0.2 V/2.0 V, VCOM = 1.5 V/0.3 V	Room Full ^d	−1 −10		1 10	nA
	ICOM(off)		Room Full ^d	−1 −10		1 10	
Channel-On Leakage Current ^f	ICOM(on)	V+ = 1.8 V, VNO, VNC = VCOM = 0.3 V/1.5 V	Room Full ^d	−1 −10		1 10	
Digital Control							
Input High Voltage	VINH		Full	1.0			V
Input Low Voltage	VINL		Full			0.4	
Input Capacitance ^d	Cin		Full		5.5		pF
Input Current ^f	IINL or IINH	VIN = 0 or V+	Full	−1		1	μA
Dynamic Characteristics							
Turn-On Time ^d	tON	VNO or VNC = 1.5 V, RL = 50 Ω, CL = 35 pF Figures 1 and 2	Room Full ^d		33	45 50	ns
Turn-Off Time ^d	tOFF		Room Full ^d		27	40 45	
Break-Before-Make Time ^d	td		Room	3			
Charge Injection ^d	QINJ	CL = 1 nF, VGEN = 0 V, RGEN = 0 Ω, Figure 3	Room		20		pC
Off-Isolation ^d	OIRR	RL = 1 kΩ, CL = 5 pF, f = 1 MHz	Room		55		dB
Crosstalk ^d	XTALK		Room		91		
NO, NC Off Capacitance ^d	CNO(off), CNC(off)	VIN = 0 or V+, f = 1 MHz	Room		88		pF
Channel-On Capacitance ^d	CON		Room		105		

SPECIFICATIONS (V+ = 3.0 V)							
Parameter	Symbol	Test Conditions Otherwise Unless Specified V+ = 3 V, ± 10%, VIN = 0.5 or 1.4 V ^e	Temp ^a	Limits –40 to 85°C			Unit
				Min ^b	Typ ^c	Max ^b	
Analog Switch							
Analog Signal Range ^d	VNO, VNC, VCOM		Full	0		V+	V
On-Resistance	rON	V+ = 2.7 V, VCOM = 0.2 V/1.5 V, INO INC = 100 mA	Room Full		0.4	0.8 0.9	Ω
rON Flatness	rON Flatness	V+ = 2.7 V, VCOM = 1.5, 2 V, INO, INC = 100 mA	Room		0.08	0.18	
rON MatchFlat	ΔrON		Room		0.05	0.08	
Switch Off Leakage Current	INO(off), INC(off)	V+ = 3.3 V VNO, VNC = 0.3 V/3 V, VCOM = 3 V/0.3 V	Room Full	–1 –10		1 10	nA
	ICOM(off)		Room Full	–1 –10		1 10	
Channel-On Leakage Current	ICOM(on)	V+ = 3.3 V, VNO, VNC = VCOM = 0.3 V/3 V	Room Full	–1 –10		1 10	
Digital Control							
Input High Voltage	VINH		Full	1.4			V
Input Low Voltage	VINL		Full			0.5	
Input Capacitance ^d	Cin		Full		5.5		pF
Input Current ^f	IINL or IINH	VIN = 0 or V+	Full	–1		1	μA
Dynamic Characteristics							
Turn-On Time	tON	VNO or VNC = 1.5 V, RL = 50 Ω, CL = 35 pF V+ = 2.7 V, Figure 1 and 2	Room Full		20	30 35	ns
Turn-Off Time	tOFF		Room Full		18	28 33	
Break-Before-Make Time	td		Room	1			
Charge Injection ^d	QINJ	CL = 1 nF, VGEN = 0 V, RGEN = 0 Ω, Figure 3	Room		5.8		pC
Off-Isolation ^d	OIRR	RL = 1 kΩ, CL = 5 pF, f = 1 MHz	Room		–56		dB
Crosstalk ^d	XTALK		Room		–89		
NO, NC Off Capacitance ^d	CNO(off), CNC(off)	V+ = 3.6 V, VIN = 0 or V+, f = 1 MHz	Room		81		pF
Channel-On Capacitance ^d	CON		Room		103		
Power Supply							
Power Supply Range	V+			1.5		3.6	V
Power Supply Current	I+	V+ = 3.6 V, VIN = 0 or V+			0.01	1.0	μA

Notes:

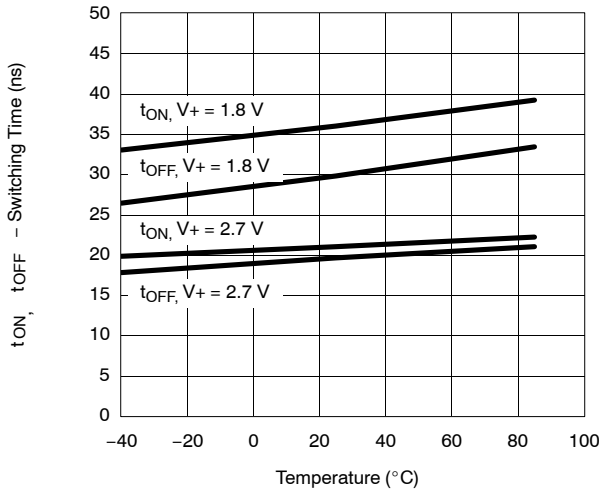
- Room = 25°C, Full = as determined by the operating suffix.
- The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- Typical values are for design aid only, not guaranteed nor subject to production testing.
- Guarantee by design, nor subjected to production test.
- V_{IN} = input voltage to perform proper function.
- Guaranteed by 3-V leakage testing, not production tested.

**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)** **$r_{DS(on)}$ vs. V_{COM} vs. $1 V_{CC}$**  **$r_{DS(on)}$ vs. V_D , V_{CC} and Temperature****Supply Current vs. Temperature****Switching Frequency vs. Supply Current****Leakage Current vs. Temperature****Leakage Current vs. Analog Voltage**

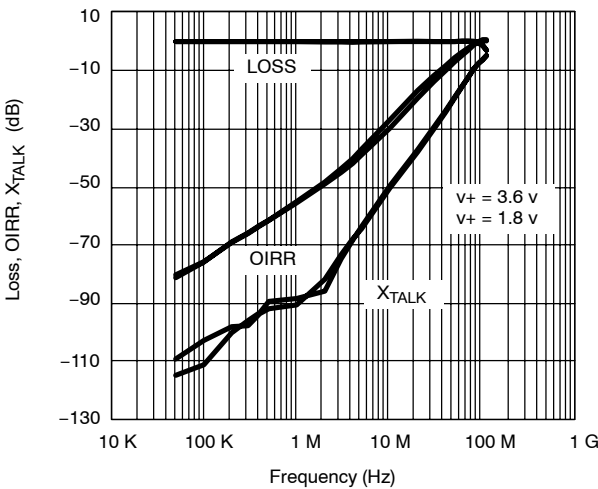


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

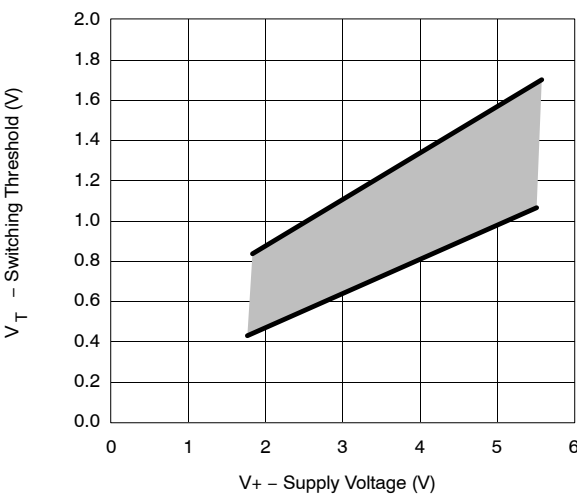
Switching Time vs. V_{CC} and Temperature



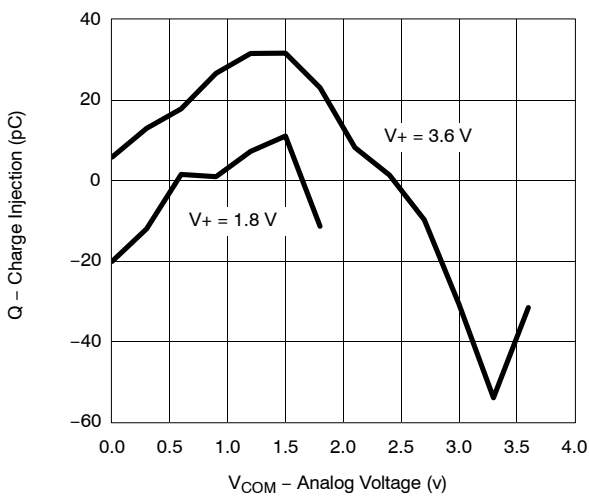
Insertion Loss, Off-Isolation, Crosstalk vs. Frequency



Switching Threshold vs. Supply Voltage



Charge Injection vs. Analog Voltage



TEST CIRCUITS

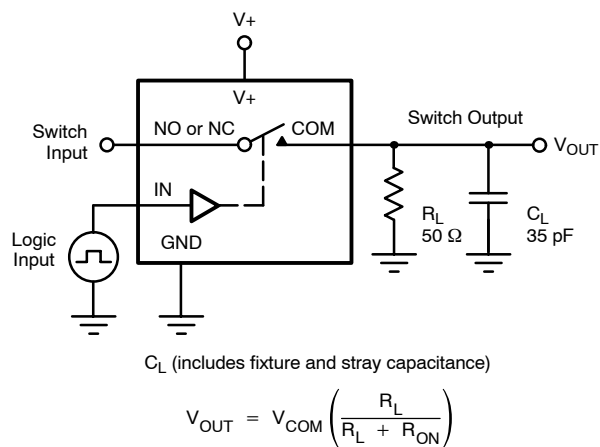


FIGURE 1. Switching Time

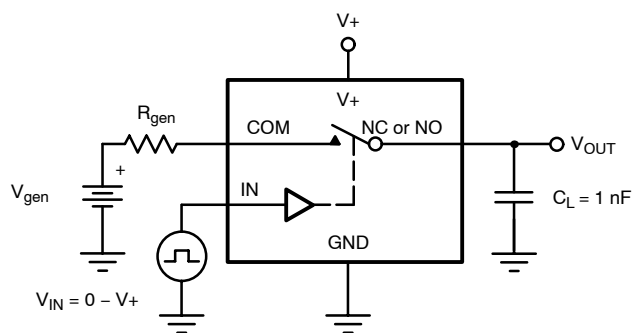
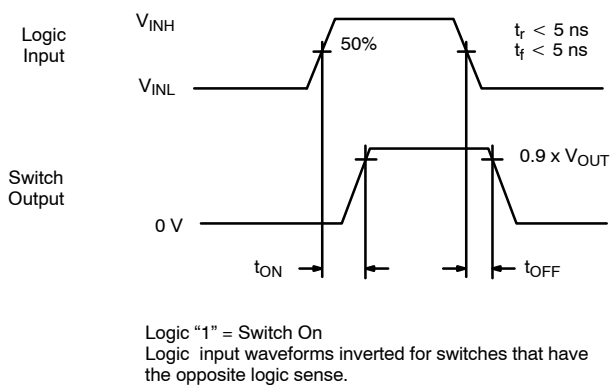


FIGURE 2. Charge Injection

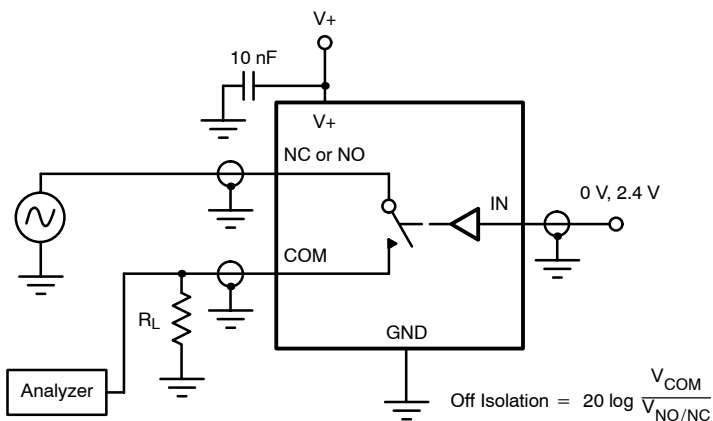
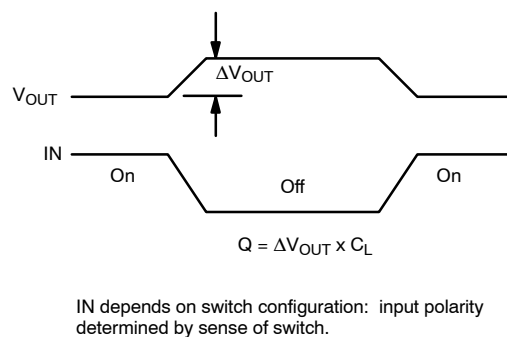


FIGURE 3. Off-Isolation

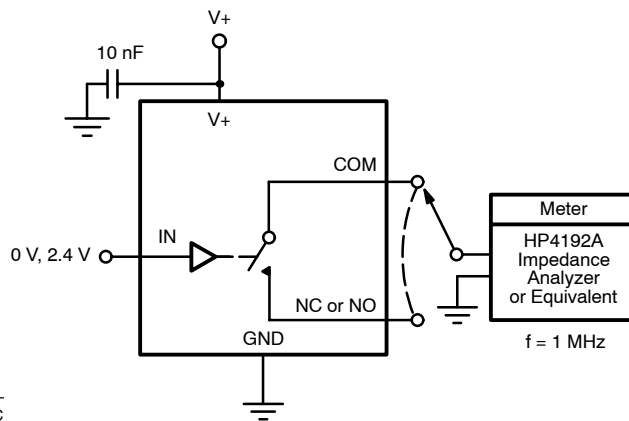


FIGURE 4. Channel Off/On Capacitance